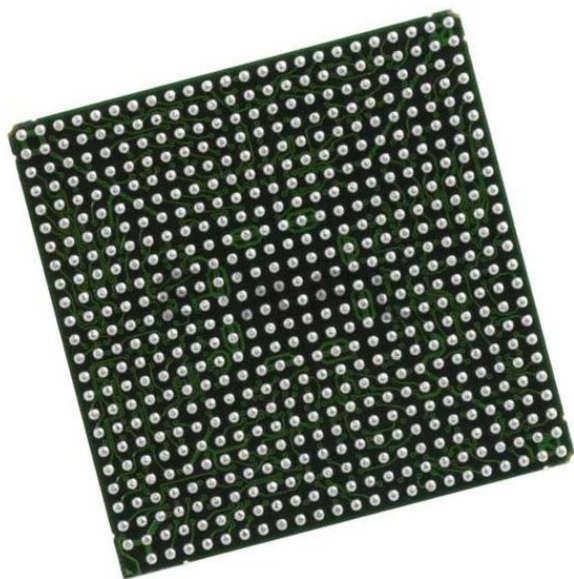




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	1920
Number of Logic Elements/Cells	-
Total RAM Bits	884736
Number of I/O	392
Number of Gates	1500000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	575-BBGA
Supplier Device Package	575-BGA (31x31)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2v1500-4bgg575i

Summary of Virtex-II™ Features

- Industry First Platform FPGA Solution
- IP-Immersion Architecture
 - Densities from 40K to 8M system gates
 - 420 MHz internal clock speed (Advance Data)
 - 840+ Mb/s I/O (Advance Data)
- SelectRAM™ Memory Hierarchy
 - 3 Mb of dual-port RAM in 18 Kbit block SelectRAM resources
 - Up to 1.5 Mb of distributed SelectRAM resources
- High-Performance Interfaces to External Memory
 - DRAM interfaces
 - SDR / DDR SDRAM
 - Network FCRAM
 - Reduced Latency DRAM
 - SRAM interfaces
 - SDR / DDR SRAM
 - QDR™ SRAM
 - CAM interfaces
- Arithmetic Functions
 - Dedicated 18-bit x 18-bit multiplier blocks
 - Fast look-ahead carry logic chains
- Flexible Logic Resources
 - Up to 93,184 internal registers / latches with Clock Enable
 - Up to 93,184 look-up tables (LUTs) or cascadable 16-bit shift registers
 - Wide multiplexers and wide-input function support
 - Horizontal cascade chain and sum-of-products support
 - Internal 3-state bussing
- High-Performance Clock Management Circuitry
 - Up to 12 DCM (Digital Clock Manager) modules
 - Precise clock de-skew
 - Flexible frequency synthesis
 - High-resolution phase shifting
 - 16 global clock multiplexer buffers
- Active Interconnect Technology
 - Fourth generation segmented routing structure
 - Predictable, fast routing delay, independent of fanout
- SelectIO™-Ultra Technology
 - Up to 1,108 user I/Os
 - 19 single-ended and six differential standards
 - Programmable sink current (2 mA to 24 mA) per I/O
 - Digitally Controlled Impedance (DCI) I/O: on-chip termination resistors for single-ended I/O standards
- PCI-X compatible (133 MHz and 66 MHz) at 3.3V
- PCI compliant (66 MHz and 33 MHz) at 3.3V
- CardBus compliant (33 MHz) at 3.3V
- Differential Signaling
 - 840 Mb/s Low-Voltage Differential Signaling I/O (LVDS) with current mode drivers
 - Bus LVDS I/O
 - Lightning Data Transport (LDT) I/O with current driver buffers
 - Low-Voltage Positive Emitter-Coupled Logic (LVPECL) I/O
 - Built-in DDR input and output registers
- Proprietary high-performance SelectLink Technology
 - High-bandwidth data path
 - Double Data Rate (DDR) link
 - Web-based HDL generation methodology
- Supported by Xilinx Foundation™ and Alliance Series™ Development Systems
 - Integrated VHDL and Verilog design flows
 - Compilation of 10M system gates designs
 - Internet Team Design (ITD) tool
- SRAM-Based In-System Configuration
 - Fast SelectMAP configuration
 - Triple Data Encryption Standard (DES) security option (Bitstream Encryption)
 - IEEE 1532 support
 - Partial reconfiguration
 - Unlimited reprogrammability
 - Readback capability
- 0.15 µm 8-Layer Metal Process with 0.12 µm High-Speed Transistors
- 1.5V (V_{CCINT}) Core Power Supply, Dedicated 3.3V V_{CCAUX} Auxiliary and V_{CCO} I/O Power Supplies
- IEEE 1149.1 Compatible Boundary-Scan Logic Support
- Flip-Chip and Wire-Bond Ball Grid Array (BGA) Packages in Three Standard Fine Pitches (0.80 mm, 1.00 mm, and 1.27 mm)
- Wire-Bond BGA Devices Available in Pb-Free Packaging (www.xilinx.com/pbfree)
- 100% Factory Tested

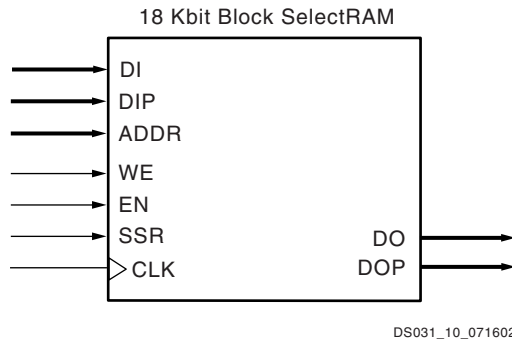


Figure 29: 18 Kbit Block SelectRAM Memory in Single-Port Mode

Dual-Port Configuration

As a dual-port RAM, each port of block SelectRAM has access to a common 18 Kbit memory resource. These are fully synchronous ports with independent control signals for each port. The data widths of the two ports can be configured independently, providing built-in bus-width conversion.

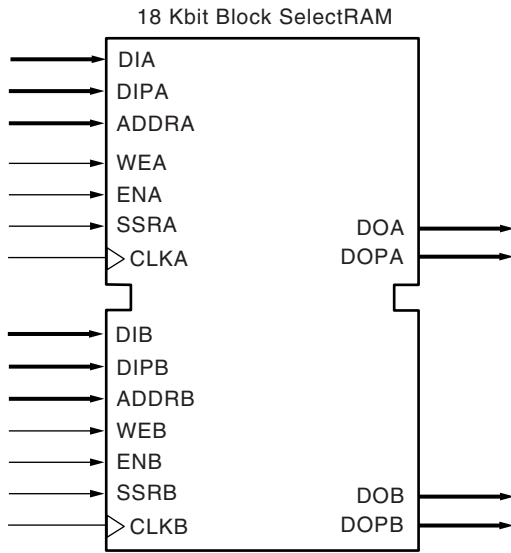
Table 15 illustrates the different configurations available on ports A and B.

If both ports are configured in either 2K x 9-bit, 1K x 18-bit, or 512 x 36-bit configurations, the 18 Kbit block is accessible from port A or B. If both ports are configured in either 16K x 1-bit, 8K x 2-bit, or 4K x 4-bit configurations, the 16 K-bit block is accessible from Port A or Port B. All other configurations result in one port having access to an 18 Kbit memory block and the other port having access to a 16 K-bit subset of the memory block equal to 16 Kbits.

Table 15: Dual-Port Mode Configurations

Port A	16K x 1	16K x 1	16K x 1	16K x 1	16K x 1	16K x 1
Port B	16K x 1	8K x 2	4K x 4	2K x 9	1K x 18	512 x 36
Port A	8K x 2	8K x 2	8K x 2	8K x 2	8K x 2	
Port B	8K x 2	4K x 4	2K x 9	1K x 18	512 x 36	
Port A	4K x 4	4K x 4	4K x 4	4K x 4		
Port B	4K x 4	2K x 9	1K x 18	512 x 36		
Port A	2K x 9	2K x 9	2K x 9			
Port B	2K x 9	1K x 18	512 x 36			
Port A	1K x 18	1K x 18				
Port B	1K x 18	512 x 36				
Port A	512 x 36					
Port B	512 x 36					

Each block SelectRAM cell is a fully synchronous memory, as illustrated in Figure 30. The two ports have independent inputs and outputs and are independently clocked.



DS031_11_071602

Figure 30: 18 Kbit Block SelectRAM in Dual-Port Mode

Port Aspect Ratios

Table 16 shows the depth and the width aspect ratios for the 18 Kbit block SelectRAM. Virtex-II block SelectRAM also includes dedicated routing resources to provide an efficient interface with CLBs, block SelectRAM, and multipliers.

Table 16: 18 Kbit Block SelectRAM Port Aspect Ratio

Width	Depth	Address Bus	Data Bus	Parity Bus
1	16,384	ADDR[13:0]	DATA[0]	N/A
2	8,192	ADDR[12:0]	DATA[1:0]	N/A
4	4,096	ADDR[11:0]	DATA[3:0]	N/A
9	2,048	ADDR[10:0]	DATA[7:0]	Parity[0]
18	1,024	ADDR[9:0]	DATA[15:0]	Parity[1:0]
36	512	ADDR[8:0]	DATA[31:0]	Parity[3:0]

Read/Write Operations

The Virtex-II block SelectRAM read operation is fully synchronous. An address is presented, and the read operation is enabled by control signals WEA and WEB in addition to ENA or ENB. Then, depending on clock polarity, a rising or falling clock edge causes the stored data to be loaded into output registers.

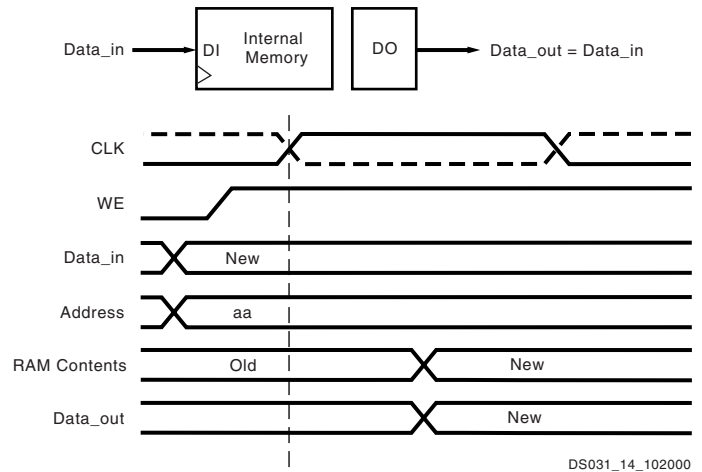
The write operation is also fully synchronous. Data and address are presented, and the write operation is enabled by control signals WEA or WEB in addition to ENA or ENB. Then, again depending on the clock input mode, a rising or

falling clock edge causes the data to be loaded into the memory cell addressed.

A write operation performs a simultaneous read operation. Three different options are available, selected by configuration:

1. "WRITE_FIRST"

The "WRITE_FIRST" option is a transparent mode. The same clock edge that writes the data input (DI) into the memory also transfers DI into the output registers DO as shown in Figure 31.



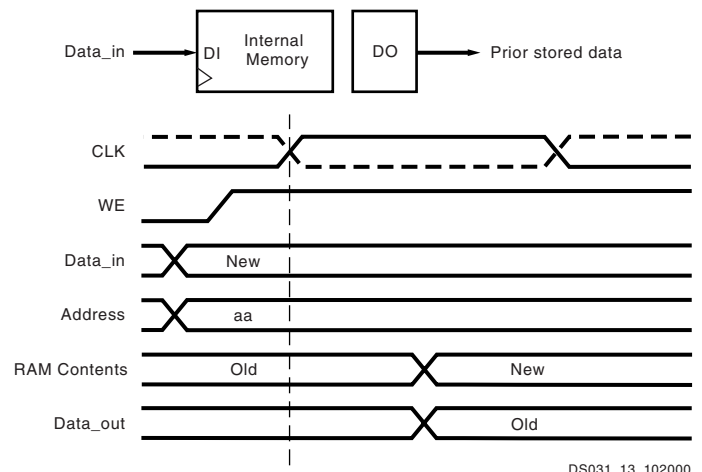
DS031_14_102000

Figure 31: WRITE_FIRST Mode

2. "READ_FIRST"

The "READ_FIRST" option is a read-before-write mode.

The same clock edge that writes data input (DI) into the memory also transfers the prior content of the memory cell addressed into the data output registers DO, as shown in Figure 32.



DS031_13_102000

Figure 32: READ_FIRST Mode

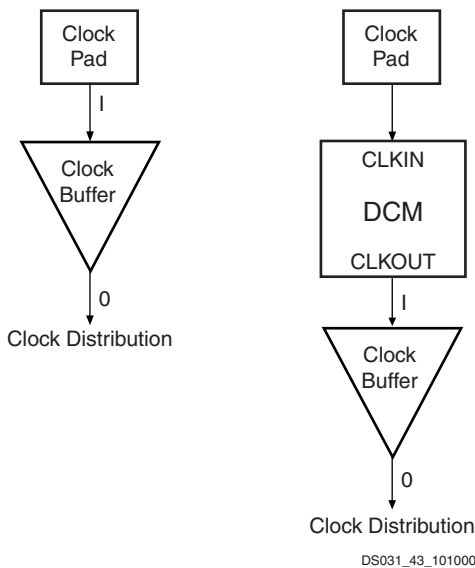


Figure 39: Virtex-II Clock Distribution Configurations

Global clock buffers are used to distribute the clock to some or all synchronous logic elements (such as registers in CLBs and IOBs, and SelectRAM blocks).

Eight global clocks can be used in each quadrant of the Virtex-II device. Designers should consider the clock distribution detail of the device prior to pin-locking and floorplanning (see the Virtex-II *User Guide*).

Figure 40 shows clock distribution in Virtex-II devices.

In each quadrant, up to eight clocks are organized in clock rows. A clock row supports up to 16 CLB rows (eight up and eight down). For the largest devices a new clock row is added, as necessary.

To reduce power consumption, any unused clock branches remain static.

Global clocks are driven by dedicated clock buffers (BUFG), which can also be used to gate the clock (BUFGCE) or to multiplex between two independent clock inputs (BUFGMUX).

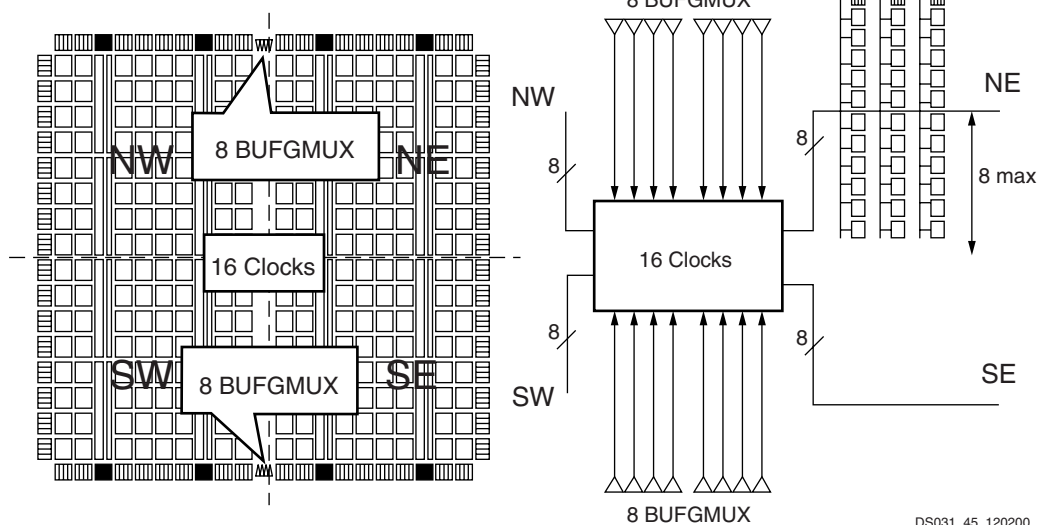


Figure 40: Virtex-II Clock Distribution

The most common configuration option of this element is as a buffer. A BUFG function in this (global buffer) mode, is shown in Figure 41.

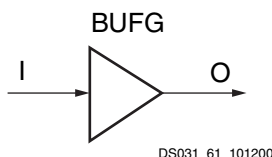


Figure 41: Virtex-II BUFG Function

The Virtex-II global clock buffer BUFG can also be configured as a clock enable/disable circuit (Figure 42), as well as a two-input clock multiplexer (Figure 43). A functional description of these two options is provided below. Each of

them can be used in either of two modes, selected by configuration: rising clock edge or falling clock edge.

This section describes the rising clock edge option. For the opposite option, falling clock edge, just change all "rising" references to "falling" and all "High" references to "Low", except for the description of the CE or S levels. The rising clock edge option uses the BUFGCE and BUFGMUX primitives. The falling clock edge option uses the BUFGCE_1 and BUFGMUX_1 primitives.

BUFGCE

If the CE input is active (High) prior to the incoming rising clock edge, this Low-to-High-to-Low clock pulse passes through the clock buffer. Any level change of CE during the incoming clock High time has no effect.

Date	Version	Revision
08/01/03	3.0	Table 13: All Virtex-II devices and speed grades now Production. - Updated values in Virtex-II Performance Characteristics and Virtex-II Switching Characteristics tables, based on values extracted from speedsfile version 1.116. Table 34 and Table 35: Revised test setup footnote to refer to Figure 1. Previously specified a capacitive load parameter. Figure 1: Added note to figure regarding termination resistors.
10/14/03	3.1	Table 1: Changed T_J description from "Operating junction temperature" to "Maximum junction temperature". - In section General Power Supply Requirements, replaced reference to Answer Record 11713 with reference to XAPP689 regarding handling of simultaneously switching outputs (SSO). - In section I/O Standard Adjustment Measurement Methodology: Table 18 renamed Input Delay Measurement Methodology. Added footnotes. - Added new Table 19, Output Delay Measurement Methodology. - Replaced Figure 1, Generalized Test Setup, with new drawing. - Revised and extended text describing output delay measurement procedure. Table 45, Table 47, and Table 48: All Source-Synchronous parameters for all devices now available in these tables. - XC2V8000 is no longer offered in the -6 speed grade. The following tables containing parameters or other references to this device/grade combination were corrected accordingly: Table 13, Table 14, Table 34, Table 35, Table 36, Table 37, Table 45, Table 47, and Table 48. Table 39: For Input Clock Low/High Pulse Width, PSCLK and CLKIN, changed existing Footnote (2) to new Footnote (3).
03/29/04	3.2	Table 4: - For XC2V40, added Maximum quiescent supply current specifications. - For all devices, updated Typical specifications for I_{CCINTQ} and I_{CCAUXQ}. - Section Power-On Power Supply Requirements, page 3: Added Footnote (1) qualifying statement that power supplies can be turned on in any sequence. - Added section Configuration Timing, page 27. This section includes new timing diagrams as well as parameter specification tables formerly included in the Virtex-II Platform FPGA User Guide. Table 20, Clock Distribution Switching Characteristics: Added parameter T_{GSI}/T_{GIS} (Global Clock Buffer S Input Setup/Hold to I1 and I2 Inputs). Table 38, Operating Frequency Ranges: Added Footnote (4) to all four CLKIN parameters. - Recompiled for backward compatibility with Acrobat 4 and above.
06/24/04	3.3	Table 1: Added T_{SOL} parameters for Pb-free package devices.
03/01/05	3.4	- Updated values in Virtex-II Performance Characteristics and Virtex-II Switching Characteristics tables, based on values extracted from speedsfile version 1.120. Table 2: Corrected Footnote (1) to require connecting V_{BATT} to V_{CCAUX} or GND if battery is not used. Table 3: Corrected "V_{REF} current per bank" to "V_{REF} current per pin." - Section Power-On Power Supply Requirements: Added word "monotonically" to description of supply voltage ramp-on requirements. Added sentence to footnote (1) indicating that if the stated requirements are violated, no damage to the device will result, but configuration will probably fail. Figure 3 and Figure 4: Corrected to show DOUT transitions driven by falling edge of CCLK.

Table 6: FG256/FGG256 BGA — XC2V40, XC2V80, XC2V250, XC2V500, and XC2V1000

Bank	Pin Description	Pin Number	No Connect in XC2V40	No Connect in XC2V80
3	IO_L96N_3	J16		
3	IO_L96P_3	J15		
3	IO_L94N_3	J14		
3	IO_L94P_3	J13		
3	IO_L93N_3/VREF_3	K16	NC	
3	IO_L93P_3	K15	NC	
3	IO_L91N_3	K14	NC	
3	IO_L91P_3	K13	NC	
3	IO_L45N_3/VREF_3	K12	NC	NC
3	IO_L45P_3	L12	NC	NC
3	IO_L43N_3	L16	NC	NC
3	IO_L43P_3	L15	NC	NC
3	IO_L06N_3	L14	NC	
3	IO_L06P_3	L13	NC	
3	IO_L04N_3	M16	NC	
3	IO_L04P_3	M15	NC	
3	IO_L03N_3/VREF_3	M14		
3	IO_L03P_3	M13		
3	IO_L02N_3/VRP_3	N15		
3	IO_L02P_3/VRN_3	N14		
3	IO_L01N_3	N16		
3	IO_L01P_3	P16		
4	IO_L01N_4/BUSY/DOUT ⁽¹⁾	T14		
4	IO_L01P_4/INIT_B	T13		
4	IO_L02N_4/D0/DIN ⁽¹⁾	P13		
4	IO_L02P_4/D1	R13		
4	IO_L03N_4/D2/ALT_VRP_4	N12		
4	IO_L03P_4/D3/ALT_VRN_4	P12		
4	IO_L04N_4/VREF_4	R12	NC	NC
4	IO_L04P_4	T12	NC	NC
4	IO_L05N_4/VRP_4	N11	NC	NC
4	IO_L05P_4/VRN_4	P11	NC	NC

Table 8: FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
1	IO_L19N_1	E20		
1	IO_L19P_1	F20		
1	IO_L06N_1	B21		
1	IO_L06P_1	B22		
1	IO_L05N_1	A22		
1	IO_L05P_1	A23		
1	IO_L04N_1	C21		
1	IO_L04P_1/VREF_1	D21		
1	IO_L03N_1/VRP_1	C20		
1	IO_L03P_1/VRN_1	D20		
1	IO_L02N_1	A24		
1	IO_L02P_1	A25		
1	IO_L01N_1	B23		
1	IO_L01P_1	B24		
2	IO_L01N_2	B26		
2	IO_L01P_2	C26		
2	IO_L02N_2/VRP_2	G20		
2	IO_L02P_2/VRN_2	H20		
2	IO_L03N_2	C25		
2	IO_L03P_2/VREF_2	D25		
2	IO_L04N_2	E23		
2	IO_L04P_2	E24		
2	IO_L06N_2	G21		
2	IO_L06P_2	G22		
2	IO_L19N_2	D26		
2	IO_L19P_2	E26		
2	IO_L21N_2	F23		
2	IO_L21P_2/VREF_2	F24		
2	IO_L22N_2	E25		
2	IO_L22P_2	F25		
2	IO_L24N_2	H22		
2	IO_L24P_2	H21		
2	IO_L25N_2	G23	NC	NC
2	IO_L25P_2	G24	NC	NC
2	IO_L43N_2	F26		
2	IO_L43P_2	G26		

Table 8: FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
6	IO_L52N_6	U1		
6	IO_L54P_6	U7		
6	IO_L54N_6	T7		
6	IO_L67P_6	U4		
6	IO_L67N_6	U3		
6	IO_L69P_6	U6		
6	IO_L69N_6/VREF_6	U5		
6	IO_L70P_6	T5		
6	IO_L70N_6	T6		
6	IO_L72P_6	T8		
6	IO_L72N_6	R8		
6	IO_L73P_6	T2	NC	
6	IO_L73N_6	T1	NC	
6	IO_L75P_6	T4	NC	
6	IO_L75N_6/VREF_6	T3	NC	
6	IO_L76P_6	R6	NC	
6	IO_L76N_6	R5	NC	
6	IO_L78P_6	R4	NC	
6	IO_L78N_6	R3	NC	
6	IO_L91P_6	R2		
6	IO_L91N_6	R1		
6	IO_L93P_6	R7		
6	IO_L93N_6/VREF_6	P7		
6	IO_L94P_6	P6		
6	IO_L94N_6	P5		
6	IO_L96P_6	P4		
6	IO_L96N_6	P3		
7	IO_L96P_7	P1		
7	IO_L96N_7	N1		
7	IO_L94P_7	N4		
7	IO_L94N_7	N5		
7	IO_L93P_7/VREF_7	N6		
7	IO_L93N_7	N7		
7	IO_L91P_7	P8		
7	IO_L91N_7	N8		
7	IO_L78P_7	M1	NC	

Table 10: BG728 BGA — XC2V3000

Bank	Pin Description	Pin Number
6	IO_L01N_6	AD1
6	IO_L02P_6/VRN_6	AD3
6	IO_L02N_6/VRP_6	AD2
6	IO_L03P_6	AC4
6	IO_L03N_6/VREF_6	AC3
6	IO_L04P_6	AC2
6	IO_L04N_6	AC1
6	IO_L06P_6	AB5
6	IO_L06N_6	AB4
6	IO_L19P_6	AB3
6	IO_L19N_6	AB2
6	IO_L21P_6	AB1
6	IO_L21N_6/VREF_6	AA1
6	IO_L22P_6	AA5
6	IO_L22N_6	AA6
6	IO_L24P_6	AA3
6	IO_L24N_6	AA2
6	IO_L25P_6	Y5
6	IO_L25N_6	Y6
6	IO_L27P_6	Y4
6	IO_L27N_6/VREF_6	Y3
6	IO_L28P_6	Y1
6	IO_L28N_6	W1
6	IO_L43P_6	W8
6	IO_L43N_6	W9
6	IO_L45P_6	W6
6	IO_L45N_6/VREF_6	W7
6	IO_L46P_6	W5
6	IO_L46N_6	W4
6	IO_L48P_6	W3
6	IO_L48N_6	W2
6	IO_L49P_6	V7
6	IO_L49N_6	V8
6	IO_L51P_6	V5
6	IO_L51N_6/VREF_6	V6
6	IO_L52P_6	V4

Table 11: FF896 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
3	IO_L24N_3	AC8		
3	IO_L24P_3	AB8		
3	IO_L23N_3	AE2		
3	IO_L23P_3	AF3		
3	IO_L22N_3	AD3		
3	IO_L22P_3	AE3		
3	IO_L21N_3/VREF_3	AD6		
3	IO_L21P_3	AD7		
3	IO_L20N_3	AF1		
3	IO_L20P_3	AG1		
3	IO_L19N_3	AD4		
3	IO_L19P_3	AE4		
3	IO_L06N_3	AD8		
3	IO_L06P_3	AE7		
3	IO_L05N_3	AG2		
3	IO_L05P_3	AH2		
3	IO_L04N_3	AD5		
3	IO_L04P_3	AE5		
3	IO_L03N_3/VREF_3	AC9		
3	IO_L03P_3	AD9		
3	IO_L02N_3/VRP_3	AH1		
3	IO_L02P_3/VRN_3	AJ1		
3	IO_L01N_3	AF4		
3	IO_L01P_3	AG3		
4	IO_L01N_4/BUSY/DOUT ⁽¹⁾	AK2		
4	IO_L01P_4/INIT_B	AJ3		
4	IO_L02N_4/D0/DIN ⁽¹⁾	AE8		
4	IO_L02P_4/D1	AF9		
4	IO_L03N_4/D2/ALT_VRP_4	AH5		
4	IO_L03P_4/D3/ALT_VRN_4	AH6		
4	IO_L04N_4/VREF_4	AJ4		
4	IO_L04P_4	AK4		
4	IO_L05N_4/VRP_4	AC10		
4	IO_L05P_4/VRN_4	AC11		
4	IO_L06N_4	AH7		
4	IO_L06P_4	AG6		

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
3	IO_L23P_3	AJ3	
3	IO_L22N_3	AF7	
3	IO_L22P_3	AG7	
3	IO_L21N_3/VREF_3	AL1	
3	IO_L21P_3	AK1	
3	IO_L20N_3	AH2	
3	IO_L20P_3	AJ2	
3	IO_L19N_3	AJ4	
3	IO_L19P_3	AK4	
3	IO_L06N_3	AE10	
3	IO_L06P_3	AD10	
3	IO_L05N_3	AK2	
3	IO_L05P_3	AL2	
3	IO_L04N_3	AH6	
3	IO_L04P_3	AJ5	
3	IO_L03N_3/VREF_3	AE11	
3	IO_L03P_3	AF11	
3	IO_L02N_3/VRP_3	AK3	
3	IO_L02P_3/VRN_3	AL3	
3	IO_L01N_3	AF10	
3	IO_L01P_3	AG9	
4	IO_L01N_4/BUSY/DOUT ⁽¹⁾	AM4	
4	IO_L01P_4/INIT_B	AL5	
4	IO_L02N_4/D0/DIN ⁽¹⁾	AG10	
4	IO_L02P_4/D1	AH11	
4	IO_L03N_4/D2/ALT_VRP_4	AK7	
4	IO_L03P_4/D3/ALT_VRN_4	AK8	
4	IO_L04N_4/VREF_4	AL6	
4	IO_L04P_4	AM6	
4	IO_L05N_4/VRP_4	AK9	
4	IO_L05P_4/VRN_4	AJ8	
4	IO_L06N_4	AM8	
4	IO_L06P_4	AM7	
4	IO_L19N_4	AN3	
4	IO_L19P_4	AM2	

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
6	IO_L29P_6	AF31	
6	IO_L29N_6	AG31	
6	IO_L30P_6	AF32	
6	IO_L30N_6	AG32	
6	IO_L43P_6	AC25	
6	IO_L43N_6	AB25	
6	IO_L44P_6	AJ33	
6	IO_L44N_6	AH33	
6	IO_L45P_6	AE31	
6	IO_L45N_6/VREF_6	AD32	
6	IO_L46P_6	AD27	
6	IO_L46N_6	AC27	
6	IO_L47P_6	AJ34	
6	IO_L47N_6	AH34	
6	IO_L48P_6	AE30	
6	IO_L48N_6	AD30	
6	IO_L49P_6	AC26	
6	IO_L49N_6	AB26	
6	IO_L50P_6	AD29	
6	IO_L50N_6	AC29	
6	IO_L51P_6	AF33	
6	IO_L51N_6/VREF_6	AG33	
6	IO_L52P_6	AC28	
6	IO_L52N_6	AB28	
6	IO_L53P_6	AF34	
6	IO_L53N_6	AE33	
6	IO_L54P_6	AB27	
6	IO_L54N_6	AA27	
6	IO_L67P_6	AA25	
6	IO_L67N_6	Y25	
6	IO_L68P_6	AD33	
6	IO_L68N_6	AC33	
6	IO_L69P_6	AC32	
6	IO_L69N_6/VREF_6	AB32	
6	IO_L70P_6	AA26	
6	IO_L70N_6	Y26	

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
1	IO_L69N_1/VREF_1	E15		
1	IO_L69P_1	E16		
1	IO_L68N_1	K17		
1	IO_L68P_1	K16		
1	IO_L67N_1	C15		
1	IO_L67P_1	B15		
1	IO_L60N_1	F15		
1	IO_L60P_1	F16		
1	IO_L59N_1	H16		
1	IO_L59P_1	H15		
1	IO_L58N_1	C13		
1	IO_L58P_1	C14		
1	IO_L57N_1/VREF_1	D13		
1	IO_L57P_1	D14		
1	IO_L56N_1	M17		
1	IO_L56P_1	M16		
1	IO_L55N_1	A12		
1	IO_L55P_1	A13		
1	IO_L54N_1	B12		
1	IO_L54P_1	B13		
1	IO_L53N_1	G15		
1	IO_L53P_1	G14		
1	IO_L52N_1	C11		
1	IO_L52P_1	C12		
1	IO_L51N_1/VREF_1	F13		
1	IO_L51P_1	F14		
1	IO_L50N_1	L16		
1	IO_L50P_1	L15		
1	IO_L49N_1	A10		
1	IO_L49P_1	A11		
1	IO_L36N_1	E12	NC	
1	IO_L36P_1	E13	NC	
1	IO_L35N_1	K15	NC	
1	IO_L35P_1	J14	NC	
1	IO_L34N_1	B9	NC	
1	IO_L34P_1	B10	NC	

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
4	IO_L08P_4	AL12	NC	
4	IO_L09N_4	AP9	NC	
4	IO_L09P_4/VREF_4	AP8	NC	
4	IO_L10N_4	AV6	NC	
4	IO_L10P_4	AV5	NC	
4	IO_L11N_4	AM11	NC	
4	IO_L11P_4	AM12	NC	
4	IO_L12N_4	AN10	NC	
4	IO_L12P_4	AN9	NC	
4	IO_L19N_4	AU8		
4	IO_L19P_4	AU7		
4	IO_L20N_4	AH14		
4	IO_L20P_4	AH15		
4	IO_L21N_4	AT8		
4	IO_L21P_4/VREF_4	AT7		
4	IO_L22N_4	AW7		
4	IO_L22P_4	AW6		
4	IO_L23N_4	AK13		
4	IO_L23P_4	AK14		
4	IO_L24N_4	AR10		
4	IO_L24P_4	AR9		
4	IO_L25N_4	AV8		
4	IO_L25P_4	AV7		
4	IO_L26N_4	AJ14		
4	IO_L26P_4	AJ15		
4	IO_L27N_4	AP11		
4	IO_L27P_4/VREF_4	AP10		
4	IO_L28N_4	AU10		
4	IO_L28P_4	AU9		
4	IO_L29N_4	AL13		
4	IO_L29P_4	AL14		
4	IO_L30N_4	AN12		
4	IO_L30P_4	AN11		
4	IO_L31N_4	AW9	NC	
4	IO_L31P_4	AW8	NC	
4	IO_L32N_4	AM13	NC	

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
7	IO_L02P_7/VRN_7	M27		
7	IO_L02N_7/VRP_7	L27		
7	IO_L01P_7	D38		
7	IO_L01N_7	E37		
0	VCCO_0	P25		
0	VCCO_0	P24		
0	VCCO_0	P23		
0	VCCO_0	P22		
0	VCCO_0	P21		
0	VCCO_0	N26		
0	VCCO_0	N25		
0	VCCO_0	N24		
0	VCCO_0	N23		
0	VCCO_0	N22		
0	VCCO_0	N21		
0	VCCO_0	L23		
0	VCCO_0	J25		
0	VCCO_0	G27		
0	VCCO_0	E29		
0	VCCO_0	C22		
0	VCCO_0	B26		
1	VCCO_1	P19		
1	VCCO_1	P18		
1	VCCO_1	P17		
1	VCCO_1	P16		
1	VCCO_1	P15		
1	VCCO_1	N19		
1	VCCO_1	N18		
1	VCCO_1	N17		
1	VCCO_1	N16		
1	VCCO_1	N15		
1	VCCO_1	N14		
1	VCCO_1	L17		
1	VCCO_1	J15		
1	VCCO_1	G13		

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
NA	DONE	AP7		
NA	M0	AN32		
NA	M1	AP33		
NA	M2	AT35		
NA	HSWAP_EN	E34		
NA	TCK	G8		
NA	TDI	D35		
NA	TDO	E6		
NA	TMS	F7		
NA	PWRDWN_B	AN8		
NA	DXN	G32		
NA	DXP	F33		
NA	VBATT	D5		
NA	RSVD	H9		
NA	VCCAUX	AV20		
NA	VCCAUX	AT37		
NA	VCCAUX	AT3		
NA	VCCAUX	Y38		
NA	VCCAUX	Y2		
NA	VCCAUX	D37		
NA	VCCAUX	D3		
NA	VCCAUX	B20		
NA	VCCINT	AG27		
NA	VCCINT	AG20		
NA	VCCINT	AG13		
NA	VCCINT	AF26		
NA	VCCINT	AF20		
NA	VCCINT	AF14		
NA	VCCINT	AE25		
NA	VCCINT	AE24		
NA	VCCINT	AE23		
NA	VCCINT	AE22		
NA	VCCINT	AE21		
NA	VCCINT	AE20		
NA	VCCINT	AE19		

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
NA	GND	D4		
NA	GND	C39		
NA	GND	C38		
NA	GND	C37		
NA	GND	C3		
NA	GND	C2		
NA	GND	C1		
NA	GND	B39		
NA	GND	B38		
NA	GND	B37		
NA	GND	B29		
NA	GND	B11		
NA	GND	B3		
NA	GND	B2		
NA	GND	B1		
NA	GND	A38		
NA	GND	A37		
NA	GND	A20		
NA	GND	A3		
NA	GND	A2		

Notes:

- See Table 4 for an explanation of the signals available on this pin.

Table 14: BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000

Bank	Pin Description	Pin Number	No Connect in XC2V2000
5	IO_L24P_5	AG23	
5	IO_L23N_5	AE22	
5	IO_L23P_5	AE23	
5	IO_L22N_5	AK25	
5	IO_L22P_5	AK26	
5	IO_L21N_5/VREF_5	AH25	
5	IO_L21P_5	AG25	
5	IO_L20N_5	AB21	
5	IO_L20P_5	AC22	
5	IO_L19N_5	AL27	
5	IO_L19P_5	AL28	
5	IO_L06N_5	AK27	
5	IO_L06P_5	AJ27	
5	IO_L05N_5/VRP_5	AD23	
5	IO_L05P_5/VRN_5	AE24	
5	IO_L04N_5	AJ26	
5	IO_L04P_5/VREF_5	AH26	
5	IO_L03N_5/D4/ALT_VRP_5	AF23	
5	IO_L03P_5/D5/ALT_VRN_5	AF24	
5	IO_L02N_5/D6	AG24	
5	IO_L02P_5/D7	AF25	
5	IO_L01N_5/RDWR_B	AK28	
5	IO_L01P_5/CS_B	AK29	
6	IO_L01P_6	AF27	
6	IO_L01N_6	AF28	
6	IO_L02P_6/VRN_6	AE26	
6	IO_L02N_6/VRP_6	AE27	
6	IO_L03P_6	AH29	
6	IO_L03N_6/VREF_6	AH30	
6	IO_L04P_6	AB22	
6	IO_L04N_6	AB23	
6	IO_L05P_6	AG28	
6	IO_L05N_6	AG29	
6	IO_L06P_6	AH31	
6	IO_L06N_6	AG31	
6	IO_L19P_6	AA22	
6	IO_L19N_6	Y22	

Table 14: BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000

Bank	Pin Description	Pin Number	No Connect in XC2V2000
7	IO_L06N_7	E28	
7	IO_L05P_7	K22	
7	IO_L05N_7	K21	
7	IO_L04P_7	F29	
7	IO_L04N_7	E29	
7	IO_L03P_7/VREF_7	H26	
7	IO_L03N_7	H25	
7	IO_L02P_7/VRN_7	G26	
7	IO_L02N_7/VRP_7	F27	
7	IO_L01P_7	D30	
7	IO_L01N_7	D29	
0	VCCO_0	C18	
0	VCCO_0	C25	
0	VCCO_0	F22	
0	VCCO_0	H18	
0	VCCO_0	L17	
0	VCCO_0	L18	
0	VCCO_0	L19	
0	VCCO_0	L20	
0	VCCO_0	M17	
0	VCCO_0	M18	
0	VCCO_0	M19	
1	VCCO_1	C7	
1	VCCO_1	C14	
1	VCCO_1	F10	
1	VCCO_1	H14	
1	VCCO_1	L12	
1	VCCO_1	L13	
1	VCCO_1	L14	
1	VCCO_1	L15	
1	VCCO_1	M13	
1	VCCO_1	M14	
1	VCCO_1	M15	
2	VCCO_2	G3	
2	VCCO_2	K6	
2	VCCO_2	M11	
2	VCCO_2	N11	

BF957 Flip-Chip BGA Package Specifications (1.27mm pitch)

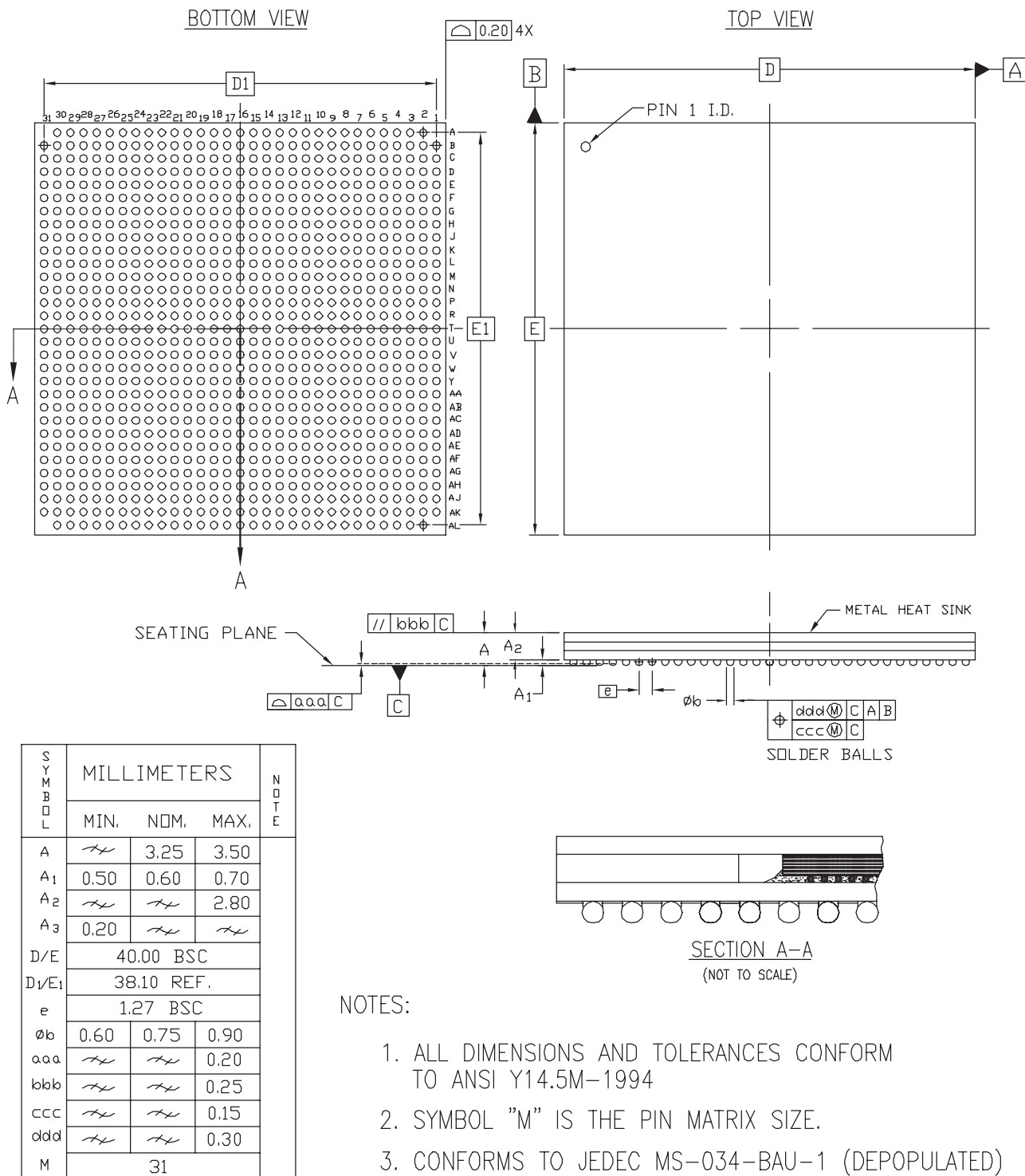


Figure 10: BF957 Flip-Chip BGA Package Specifications